

## HA-2420/883

### *Fast Sample and Hold*

The HA-2420/883 is a monolithic circuit consisting of a high performance operational amplifier with its output in series with an ultra-low leakage analog switch and MOSFET input unity gain amplifier

With an external hold capacitor connected to the switch output, a versatile, high performance sample-and-hold or track-and-hold circuit is formed. When the switch is closed, the device behaves as an operational amplifier, and any of the standard op amp feedback networks may be connected around the device to control gain, frequency response etc. When the switch is opened the output will remain at its last level.

### **Rochester Electronics Manufactured Components**

Rochester branded components are manufactured using either die/wafers purchased from the original suppliers or Rochester wafers recreated from the original IP. All re-creations are done with the approval of the Original Component Manufacturer (OCM).

Parts are tested using original factory test programs or Rochester developed test solutions to guarantee product meets or exceeds the OCM data sheet.

### **Quality Overview**

- ISO-9001
- AS9120 certification
- Qualified Manufacturers List (QML) MIL-PRF-35835
  - Class Q Military
  - Class V Space Level
- Qualified Suppliers List of Distributors (QSLD)
  - Rochester is a critical supplier to DLA and meets all industry and DLA standards.

Rochester Electronics, LLC is committed to supplying products that satisfy customer expectations for quality and are equal to those originally supplied by industry manufacturers.

*The original manufacturer's datasheet accompanying this document reflects the performance and specifications of the Rochester manufactured version of this device. Rochester Electronics guarantees the performance of its semiconductor products to the original OCM specifications. 'Typical' values are for reference purposes only. Certain minimum or maximum ratings may be based on product characterization, design, simulation, or sample testing.*

**FOR REFERENCE ONLY**



January 1989

Fast Sample and Hold

### Features

- This Circuit is Processed in Accordance to Mil-Std-883 and is Fully Conformant Under the Provisions of Paragraph 1.2.1.
- Maximum Acquisition Time (10V Step to 0.1%).....4 $\mu$ s  
(10V Step to 0.01%).....6 $\mu$ s
- Maximum Drift Current (Max. Over Temp.).....10nA
- TTL Compatible Control Input
- Power Supply Rejection ..... > 80dB

### Applications

- Data Acquisition Systems
- D to A Deglitcher
- Auto Zero Systems
- Peak Detector
- Gated Op Amp

### Description

The HA-2420/883 is a monolithic circuit consisting of a high performance operational amplifier with its output in series with an ultra-low leakage analog switch and MOSFET input unity gain amplifier.

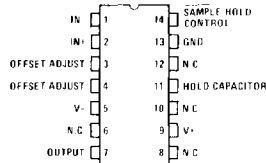
With an external hold capacitor connected to the switch output, a versatile, high performance sample-and-hold or track-and-hold circuit is formed. When the switch is closed, the device behaves as an operational amplifier, and any of the standard op amp feedback networks may be connected around the device to control gain, frequency response, etc. When the switch is opened the output will remain at its last level.

Performance as a sample-and-hold compares very favorably with other monolithic, hybrid, modular, and discrete circuits. Accuracy to better than 0.01% is achievable over the temperature range. Fast acquisition is coupled with superior droop characteristics, even at high temperatures. High slew rate, wide bandwidth, and low acquisition time produce excellent dynamic characteristics. The ability to operate at gains greater than 1 frequently eliminates the need for external scaling amplifiers.

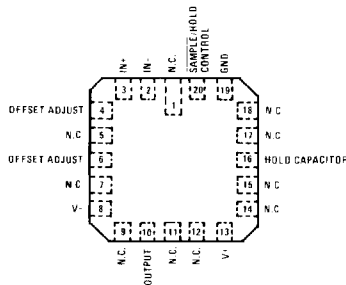
The device may also be used as a versatile operational amplifier with a gated output for applications such as analog switches, peak holding circuits, etc. For more information, please see Application Note 517.

### Pinouts

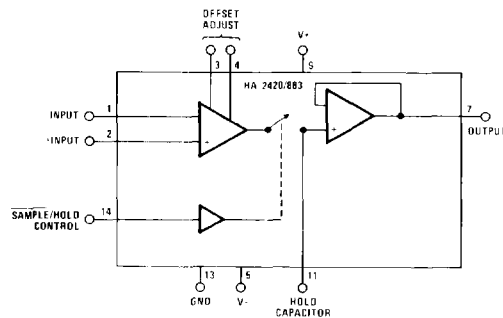
HA1-2420/883 (CERAMIC DIP)  
TOP VIEW



HA4-2420/883 (CERAMIC LCC)  
TOP VIEW



### Functional Diagram



NOTE: Pin Numbers Correspond to DIP Package Only

# Specifications HA-2420/883

## Absolute Maximum Ratings

Voltage Between V+ and V- Terminals	40V
Differential Input Voltage	±24V
Digital Input Voltage (S/H Pin)	+8V, -15V
Output Current	Short Circuit Protected
Storage Temperature Range	-65°C < T <sub>A</sub> < +150°C
Lead Temperature (Soldering 10 Seconds)	275°C
Junction Temperature	+175°C
Thermal Resistance, Junction-to-Case (θ <sub>JC</sub> )	
Ceramic DIP Package	24°C/W
Ceramic LCC Package	20°C/W

Thermal Resistance, Junction-to-Ambient (θ <sub>JA</sub> )	
Ceramic DIP Package	96°C/W
Ceramic LCC Package	88°C/W
Power Dissipation	
Ceramic DIP Package	1.03W @ +75°C
Ceramic LCC Package	1.14W @ +75°C
Power Dissipation Derating Factor (Above +75°C)	
Ceramic DIP Package	10mW/°C
Ceramic LCC Package	11.4mW/°C
ESD Classification	≤ 2000V

## Recommended Operating Conditions

Operating Temperature Range	-55°C < T <sub>A</sub> < +125°C
Operating Supply Voltage (±V <sub>SUPPLY</sub> )	±15V
Analog Input Voltage (V <sub>S</sub> )	±10V

Logic Level Low (V <sub>IL</sub> )	0V to 0.8V
Logic Level High (V <sub>IH</sub> )	2.0V to 5.0V

**TABLE 1. D.C. ELECTRICAL PERFORMANCE CHARACTERISTICS**

Device Tested at V+ = +15V; V- = -15V; V<sub>IL</sub> = 0.8V (Sample); V<sub>IH</sub> = 2.0V (Hold); C<sub>H</sub> = 1000pF, -Input Tied to Output, Unless Otherwise Specified

D.C. PARAMETERS	SYMBOL	CONDITIONS	GROUP A SUBGROUPS	TEMPERATURE	LIMITS		UNITS
					MIN	MAX	
Input Offset Voltage	V <sub>IO</sub>		1	+25°C	-4	4	mV
			2, 3	-55°C, +125°C	-6	6	mV
Input Bias Current	I <sub>B+</sub>		1	+25°C	-200	200	nA
			2, 3	-55°C, +125°C	-400	400	nA
	I <sub>B-</sub>		1	+25°C	-200	200	nA
			2, 3	-55°C, +125°C	-400	400	nA
Input Offset Current	I <sub>IO</sub>		1	+25°C	-50	50	nA
			2, 3	-55°C, +125°C	-100	100	nA
Open Loop Voltage Gain	+A <sub>VS</sub>	R <sub>L</sub> = 2kΩ, C <sub>L</sub> = 50pF, V <sub>O</sub> = +10V	1	+25°C	25k	—	V/V
			2, 3	-55°C, +125°C	25k	—	V/V
	-A <sub>VS</sub>		1	+25°C	25k	—	V/V
			2, 3	-55°C, +125°C	25k	—	V/V
Common Mode Rejection Ratio	-CMRR	V+ = 25V, V- = -5V, V <sub>O</sub> = +10V, V <sub>S/H</sub> = 10.8V	1	+25°C	80	—	dB
			2, 3	-55°C, +125°C	80	—	dB
	+CMRR		1	+25°C	80	—	dB
			2, 3	-55°C, +125°C	80	—	dB
Output Current	+I <sub>O</sub> -I <sub>O</sub>	V <sub>O</sub> = +10V V <sub>O</sub> = -10V	1	+25°C	+15.0	—	mA
			1	+25°C	-15.0	—	mA
Output Voltage Swing	+V <sub>OP</sub>	R <sub>L</sub> = 2kΩ, C <sub>L</sub> = 50pF	1	+25°C	+10.0	—	V
			2, 3	-55°C, +125°C	+10.0	—	V
	-V <sub>OP</sub>		1	+25°C	—	-10.0	V
			2, 3	-55°C, +125°C	—	-10.0	V
Power Supply Current	+I <sub>CC</sub> -I <sub>CC</sub>		1	+25°C	—	5.5	mA
			1	+25°C	-3.5	—	mA
Power Supply Rejection Ratio	+PSRR	V+ = 10V, 20V V- = -15V, -15V	1	+25°C	80	—	dB
			2, 3	-55°C, +125°C	80	—	dB
	-PSRR		1	+25°C	80	—	dB
			2, 3	-55°C, +125°C	80	—	dB
Digital Input Current	I <sub>IN1</sub>	V <sub>IN1</sub> = 0V V <sub>IN2</sub> = 5.0V	1	+25°C	—	800	μA
			2, 3	-55°C, +125°C	—	800	μA
	I <sub>IN2</sub>		1	+25°C	—	20	μA
			2, 3	-55°C, +125°C	—	20	μA
Digital Input Voltage	V <sub>IL</sub>		1	+25°C	—	0.8	V
			2, 3	-55°C, +125°C	—	0.8	V
	V <sub>IH</sub>		1	+25°C	2.0	—	V
			2, 3	-55°C, +125°C	2.0	—	V
Drift Current	I <sub>D</sub>	V <sub>IN</sub> = 0V, R <sub>L</sub> = 2kΩ, C <sub>L</sub> = 50pF, S/H = 4.0V	2	+125°C	-10	10	nA

CAUTION: These devices are sensitive to electrostatic discharge. Proper IC handling procedures should be followed.

**TABLE 2. A.C. ELECTRICAL PERFORMANCE CHARACTERISTICS**

Device Tested at  $V^+ = +15V$ ,  $V^- = -15V$ ,  $V_{IL} = 0.8V$  (Sample),  $V_{IH} = 2.0V$  (Hold),  $C_H = 1000pF$ , -Input Tied to Output, Unless Otherwise Specified

A.C. PARAMETERS	SYMBOL	CONDITIONS	GROUP A SUBGROUP	TEMP	LIMITS		UNITS
					MIN	MAX	
Hold Step Error	V <sub>ERROR</sub>	$V_{IN} = 0V, 4V, t_{rise}(V_{S/H}) = 30ns$	4	+25°C	-20	20	mV
Transient Response Rise Time & Fall Time	TR <sub>(tr)</sub>	$C_L = 50pF, R_L = 2k\Omega, A_V = +1,$ $V_{OUT} = 200mV$ peak-to-peak	4	+25°C	—	100	ns
	TR <sub>(tf)</sub>	$C_L = 50pF, R_L = 2k\Omega, A_V = +1,$ $V_{OUT} = 200mV$ peak-to-peak	4	+25°C	—	100	ns
Transient Response Overshoot	TR <sub>(+OS)</sub>	$C_L = 50pF, R_L = 2k\Omega, A_V = +1,$ $V_{OUT} = 200mV$ peak-to-peak	4	+25°C	—	40	%
	TR <sub>(-OS)</sub>	$C_L = 50pF, R_L = 2k\Omega, A_V = +1,$ $V_{OUT} = 200mV$ peak-to-peak	4	+25°C	—	40	%
Transient Response Slew Rate	TR <sub>(+SR)</sub>	$C_L = 50pF, R_L = 2k\Omega, A_V = +1,$ $V_{OUT} = 10V$ peak-to-peak	4	+25°C	3.5	—	V/ $\mu$ s
	TR <sub>(-SR)</sub>	$C_L = 50pF, R_L = 2k\Omega, A_V = +1,$ $V_{OUT} = 10V$ peak-to-peak	4	+25°C	3.5	—	V/ $\mu$ s

**TABLE 3. ELECTRICAL PERFORMANCE CHARACTERISTICS**

Device Characterized at  $V^+ = +15V$ ,  $V^- = -15V$ ,  $V_{IL} = 0.8V$  (Sample),  $V_{IH} = 2.0V$  (Hold),  $C_H = 1000pF$ , -Input Tied to Output, Unless Otherwise Specified

PARAMETER	SYMBOL	CONDITIONS	NOTE	TEMP	LIMITS		UNITS
					MIN	MAX	
Hold Mode Feedthru Attenuation	V <sub>atten</sub>	$R_L = 2k\Omega, C_L = 50pF, A_V = +1,$ $V_{IN} = 20V_{p-p}, f_{IN} = 50kHz$	1	+25°C, -55°C, +125°C	70	—	dB
Gain Bandwidth Product	GBWP	$R_L = 2k\Omega, C_L = 50pF, A_V = +1,$ $V_{IN} = 100mV_{p-p}$	1	+25°C,	2.5	—	MHz
Acquisition Time (0.1%)	+ <sub>tacq</sub> (0.1%)	$R_L = 2k\Omega, C_L = 50pF, A_V = +1,$ $V_{OUT} = 0V, +10V$	1	+25°C,	—	4	$\mu$ s
	- <sub>tacq</sub> (0.1%)	$R_L = 2k\Omega, C_L = 50pF, A_V = +1,$ $V_{OUT} = 0V, -10V$	1	+25°C,	—	4	$\mu$ s
Acquisition Time (0.01%)	+ <sub>tacq</sub> (0.01%)	$R_L = 2k\Omega, C_L = 50pF, A_V = +1,$ $V_{OUT} = 0V, +10V$	1	+25°C,	—	6	$\mu$ s
	- <sub>tacq</sub> (0.01%)	$R_L = 2k\Omega, C_L = 50pF, A_V = +1,$ $V_{OUT} = 0V, -10V$	1	+25°C,	—	6	$\mu$ s

NOTE: 1. The parameters listed in this table are controlled via design or process parameters and are not directly tested. These parameters are characterized upon initial design release and upon design changes which would affect these characteristics.

**TABLE 4. ELECTRICAL TEST REQUIREMENTS**

MIL-STD-883 TEST REQUIREMENTS	SUBGROUPS (SEE TABLES 1, 2 & 3)
Interim Electrical Parameters (Pre Burn-In)	1
Final Electrical Test Parameters	1*, 2, 3, 4
Group A Test Requirements	1, 2, 3, 4
Groups C & D Endpoints	1

\* PDA applies to Subgroup 1 only. No other subgroups are included in PDA.

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SAMPLE & HOLD  
AMPLIFIERS

CAUTION: These devices are sensitive to electrostatic discharge. Proper IC handling procedures should be followed.



CHART A. TEST CIRCUIT CONDITIONS (SEE TEST CIRCUIT — FIGURE 1)

PARAMETER	NOTES	APPLY (IN VOLTS DC)				SWITCH POSITION								MEASURE		MEASURED PARAMETER EQUATION	UNITS	
		+V	-V	VDC	S/H	EQU	S1	S2	S3	S4	S5	S6	S7	S8	VALUE			UNITS
V <sub>IO</sub>		15	-15	0	0.8	—	1	1	1	1	1	1	1	1	E1	V	$V_{IO} = E1/200$	mV
I <sub>IO</sub>		15	-15	0	0.8	—	—	—	—	—	—	—	—	—		V	$I_{IO} = (E7-E10)/10^6$	nA
I <sub>B+</sub>		15	-15	0	0.8	—	2	1	1	1	2	1	4	E7	V	$I_{B+} = E7/10^6$	nA	
I <sub>B-</sub>		15	-15	0	0.8	—	1	1	1	1	2	1	4	E10	V	$I_{B-} = E10/10^6$	nA	
+A <sub>VS</sub>	1	15	-15	0	0.8	—	1	1	1	2	1	1	1	E25	V	$+A_{VS} = 20\log_{10} [(E25-E26)/200]$	dB	
-A <sub>VS</sub>	1	15	-15	-10	0.8	—	1	1	1	2	1	1	1	E26	V			
	1	15	-15	0	0.8	—	1	1	1	2	1	1	1	E27	V			
	1	15	-15	+10	0.8	—	1	1	1	2	1	1	1	E28	V	$-A_{VS} = 20\log_{10} [(E27-E28)/200]$	dB	
-CMRR	4	25	-5	-10	10.8	—	1	1	1	1	1	1	1	E17	V	$-CMRR = 20\log_{10} [10/((E1-E17)/200)]$	dB	
+CMRR	5	5	-25	+10	-9.2	—	1	1	1	1	1	1	1	E18	V	$+CMRR = 20\log_{10} [10/((E1-E18)/200)]$	dB	
+I <sub>O</sub>		15	-15	-13	0.8	10	1	1	3	1	1	1	3	I21	mA	$+I_O = I21$	mA	
-I <sub>O</sub>		15	-15	+13	0.8	-10	1	1	3	1	1	1	3	I22	mA	$-I_O = I22$	mA	
+V <sub>OP</sub>	1	15	-15	-14	0.8	—	1	1	3	2	1	1	3	E23	V	$+V_{OP} = E23$	V	
-V <sub>OP</sub>	1	15	-15	+14	0.8	—	1	1	3	2	1	1	3	E24	V	$-V_{OP} = E24$	V	
+I <sub>CC</sub>		15	-15	0	0.8	—	1	1	1	1	1	1	1		mA		mA	
-I <sub>CC</sub>		15	-15	0	0.8	—	1	1	1	1	1	1	1		mA		mA	
+PSRR	10	-15	0	0.8	—	—	1	1	1	1	1	1	1	E13	V	$+PSRR = 20\log_{10} [10/(E13-E14)]$	dB	
	20	-15	0	0.8	—	—	1	1	1	1	1	1	1	E14	V			
-PSRR	15	-10	0	0.8	—	—	1	1	1	1	1	1	1	E15	V	$-PSRR = 20\log_{10} [10/(E15-E16)]$	dB	
	15	-20	0	0.8	—	—	1	1	1	1	1	1	1	E16	V			
I <sub>IN1</sub>		15	-15	0	0	—	1	1	1	1	1	1	1	I <sub>S/H</sub>	μA		μA	
I <sub>IN2</sub>		15	-15	0	5	—	1	1	1	1	1	1	1	I <sub>S/H</sub>	μA		μA	
I <sub>D</sub>	1,6	15	-15	0	4.0	—	1	1	3	2	1	2	1	A <sub>OUT</sub>	mV	$I_D = C_H \times \Delta V / \Delta T$	nA	
Hold Step Error	1,6	15	-15	0	0	—	1	1	3	2	1	2	1	A <sub>OUT1</sub>	mV	Error =  A <sub>OUT1</sub> -A <sub>OUT2</sub>	mV	
		15	-15	0	4.0	—	1	1	3	2	1	2	1	A <sub>OUT2</sub>	mV			
TR <sub>(tr)</sub>	2	15	-15	—	0.8	—	1	1	3	2	1	2	1	A <sub>OUT</sub>	See Notes	TR <sub>(tr)</sub> = 10% to 90%	ns	
TR <sub>(ft)</sub>	2	15	-15	—	0.8	—	1	1	3	2	1	2	1	A <sub>OUT</sub>	See Notes	TR <sub>(ft)</sub> = 90% to 10%	ns	
TR <sub>(+OS)</sub>	2	15	-15	—	0.8	—	1	1	3	2	1	2	1	A <sub>OUT</sub>	See Notes	TR <sub>(+OS)</sub> = (V <sub>peak</sub> -V <sub>final</sub> )/V <sub>final</sub> x 100	%	
TR <sub>(-OS)</sub>	2	15	-15	—	0.8	—	1	1	3	2	1	2	1	A <sub>OUT</sub>	See Notes	TR <sub>(-OS)</sub> = (V <sub>peak</sub> -V <sub>final</sub> )/V <sub>final</sub> x 100	%	
TR <sub>(+SR)</sub>	3	15	-15	—	0.8	—	1	1	3	2	1	2	1	A <sub>OUT</sub>	See Notes	TR <sub>(+SR)</sub> = ΔV/ΔT	V/μs	
TR <sub>(-SR)</sub>	3	15	-15	—	0.8	—	1	1	3	2	1	2	1	A <sub>OUT</sub>	See Notes	TR <sub>(-SR)</sub> = ΔV/ΔT	V/μs	

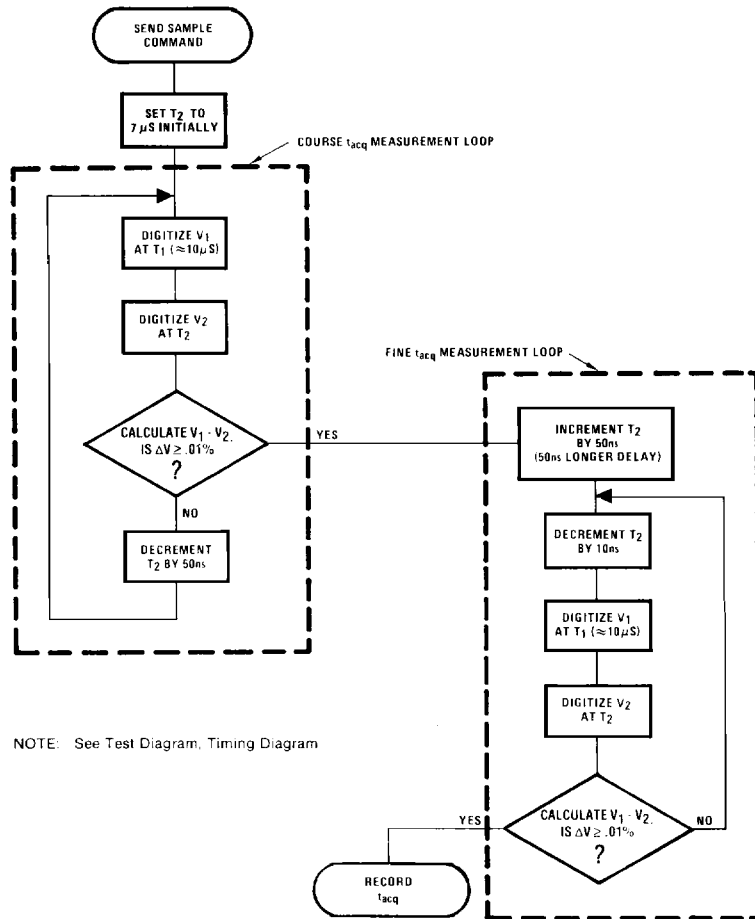
- NOTES: 1. R<sub>LDC</sub> = 2kΩ  
 2. V<sub>OUT</sub> = 200mV<sub>p-p</sub>, R<sub>L</sub> = 2kΩ, C<sub>L</sub> = 50pF  
 3. V<sub>OUT</sub> = 10V Step, R<sub>L</sub> = 2kΩ, C<sub>L</sub> = 50pF  
 4. Package GND held at +10V for this test.  
 5. Package GND held at -10V for this test.  
 6. V<sub>AC</sub> = 0V

7  
 SAMPLE & HOLD  
 AMPLIFIERS

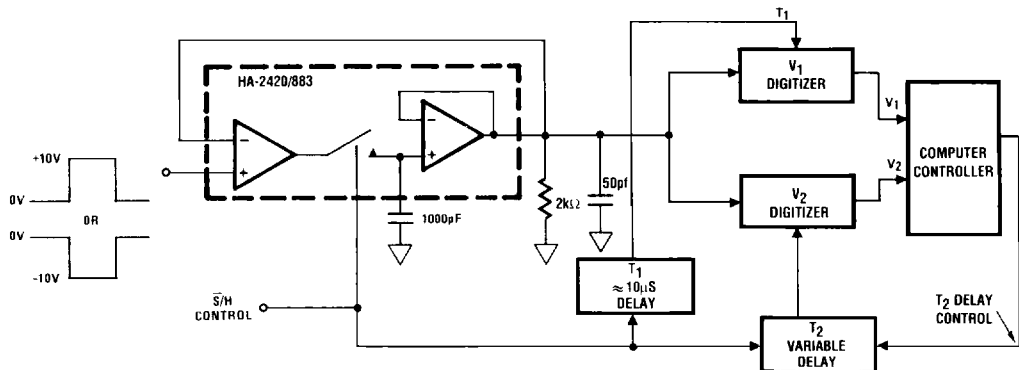
Test Circuits (Continued)

ACQUISITION TIME

( $t_{acq}$  to 0.01% is shown,  $t_{acq}$  to 0.1% is done in the same manner)

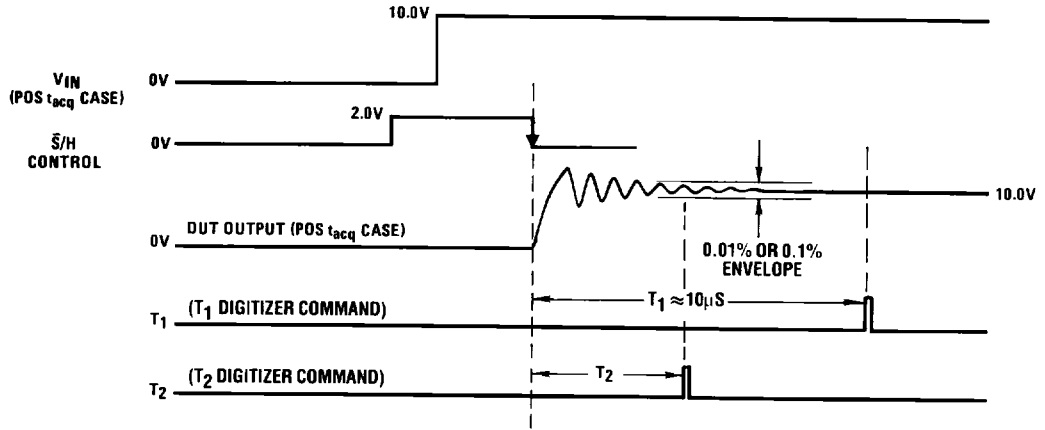


NOTE: See Test Diagram, Timing Diagram

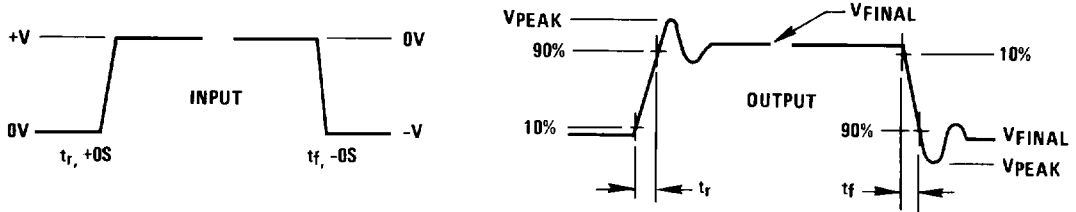


**Timing Waveforms**

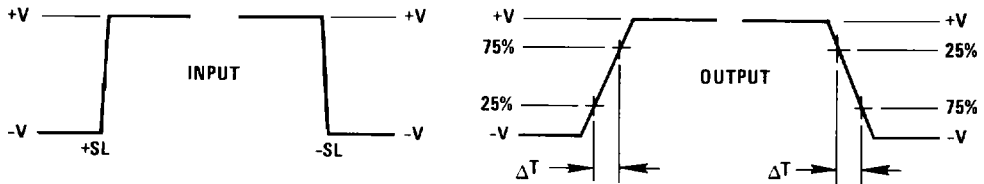
TIMING DIAGRAM FOR ACQUISITION TIME, (POSITIVE  $t_{acq}$  CASE)



OVERSHOOT, RISE & FALL TIME WAVEFORMS



SLEW RATE WAVEFORMS

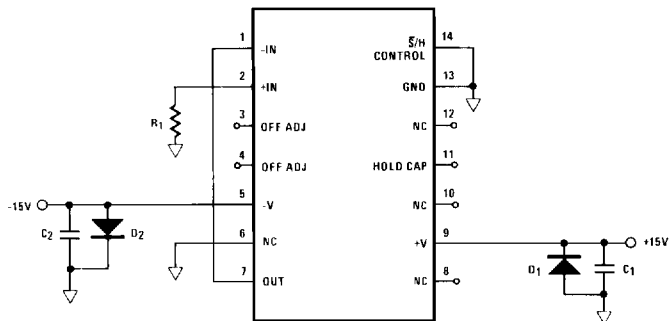




# HA-2420/883

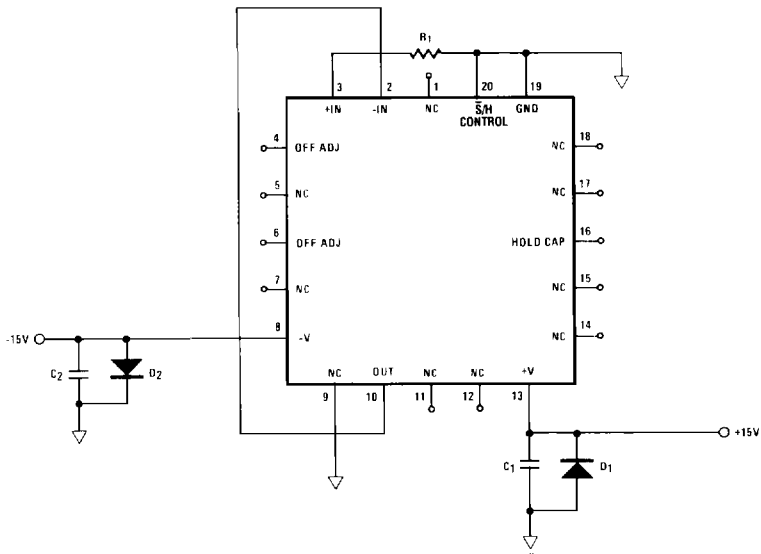
## Burn-In Circuits

HA-2420/883 (CERAMIC DIP)



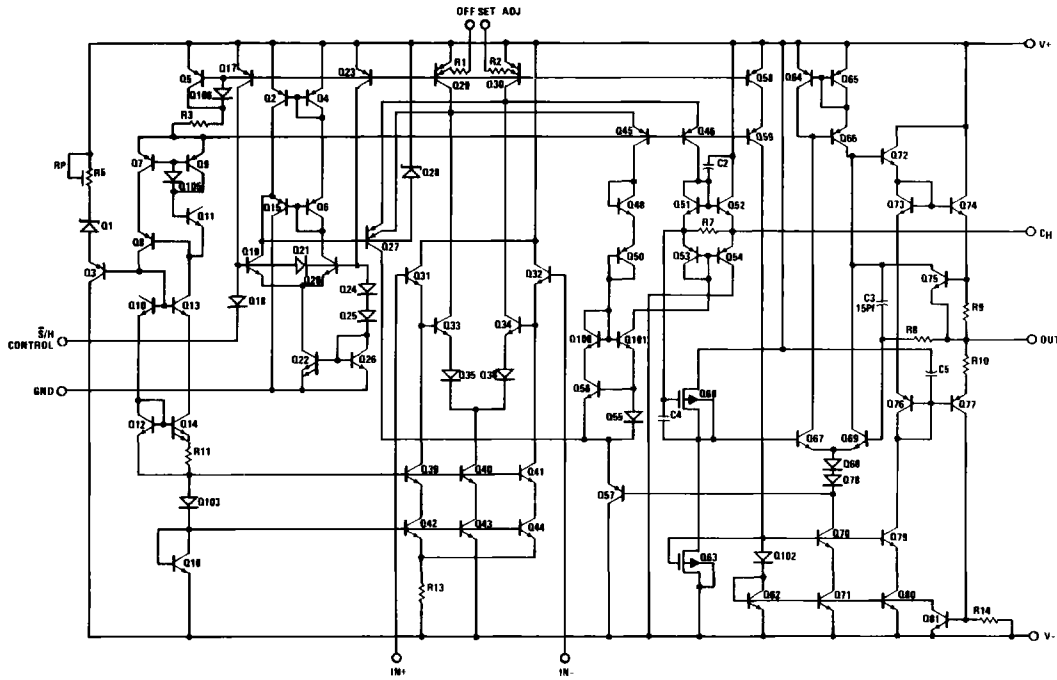
- $R_1 = 100k\Omega, \pm 5\%$  (per socket)
- $C_1 = C_2 = 0.1\mu F$  (one per row) or  $0.01\mu F$  (one per socket)
- $D_1 = D_2 = 1N4002$  or equivalent (per board)

HA-2420/883 (CERAMIC LCC)



- $R_1 = 100k\Omega, \pm 5\%$  (per socket)
- $C_1 = C_2 = 0.1\mu F$  (one per row) or  $0.01\mu F$  (one per socket)
- $D_1 = D_2 = 1N4002$  or equivalent (per board)

Schematic Diagram



# HA-2420/883

## Die Characteristics

**DIE DIMENSIONS:** 97 x 61 x 19 mils

**METALLIZATION**

Type: Al

Thickness:  $16\text{k}\text{\AA} \pm 2\text{k}\text{\AA}$

**GLASSIVATION**

Type: SiOx

Thickness:  $14\text{k}\text{\AA} \pm 2\text{k}\text{\AA}$

**WORST CASE CURRENT DENSITY:**  $1.7 \times 10^5 \text{ A/cm}^2$

**TRANSISTOR COUNT:**

HA-2420/883 78

**PROCESS:** Bipolar-DI

**DIE ATTACH**

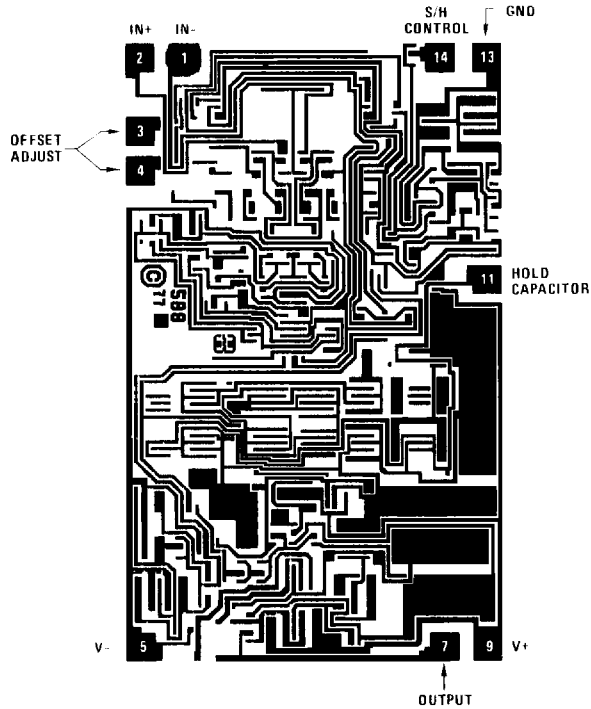
Material: Gold/Silicon Eutectic Alloy

Temperature: Ceramic DIP — 460°C (Max)

Ceramic LCC — 420°C (Max)

## Metallization Mask Layout

HA-2420/883



NOTE: Pad Numbers Correspond to DIP Package Only.



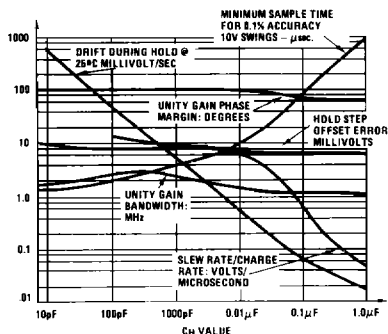
## DESIGN INFORMATION

### Fast Sample and Hold

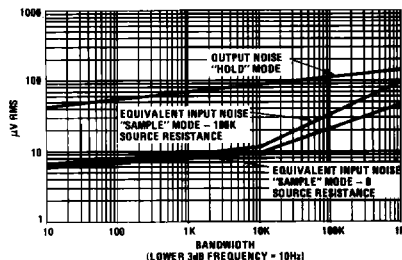
The information contained in this section has been developed through characterization by Harris Semiconductor and is for use as application and design data only. No guarantee is implied.

**Typical Performance Curves** Unless Otherwise Specified:  $V_{SUPPLY} = \pm 15VDC$ ,  $T_A = +25^\circ C$ ,  $C_H = 1000pF$

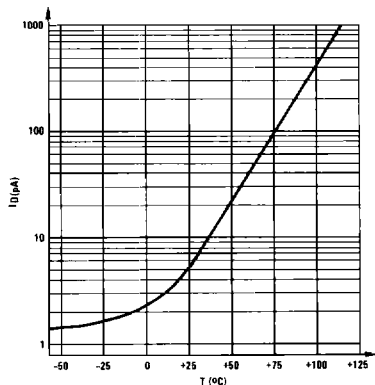
#### TYPICAL SAMPLE AND HOLD PERFORMANCE AS A FUNCTION OF HOLDING CAPACITOR



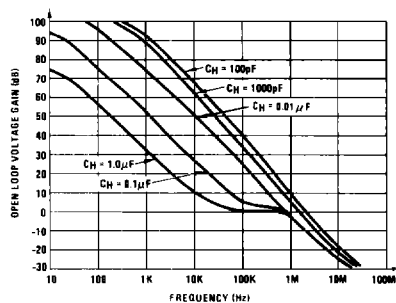
#### BROADBAND NOISE CHARACTERISTICS



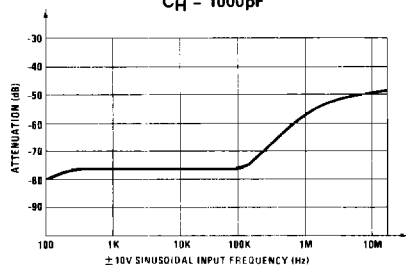
#### DRIFT CURRENT vs. TEMPERATURE



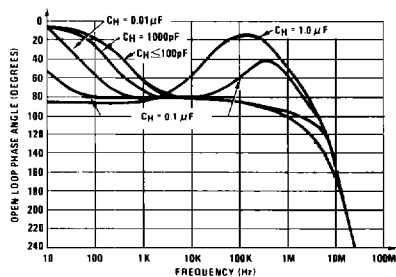
#### OPEN LOOP FREQUENCY RESPONSE



#### HOLD MODE FEEDTHROUGH ATTENUATION $C_H = 1000pF$



#### OPEN LOOP PHASE RESPONSE



## DESIGN INFORMATION (Continued)

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### Offset and Gain Adjustment

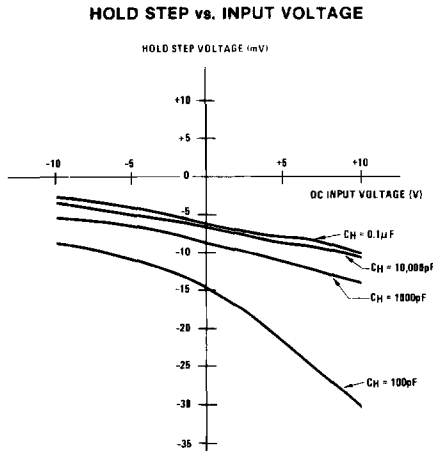


FIGURE 1.

### BASIC SAMPLE-AND-HOLD (TOP VIEW)

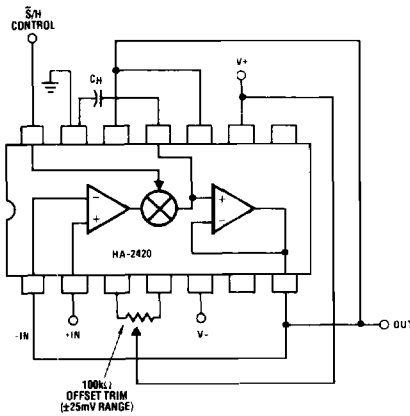


FIGURE 2.

### OFFSET ADJUSTMENT

The offset voltage of the HA-2420 may be adjusted using a 100kΩ trim pot, as shown in Figure 2. The recommended adjustment procedure is:

1. Apply zero volts to the sample-and-hold input, and a square wave to the  $\overline{S/H}$  control.
2. Adjust the trim pot for zero volts output in the hold mode.

### GAIN ADJUSTMENT

The linear variation in pedestal voltage with sample-and-hold input voltage causes a -0.06% gain error ( $C_H = 1000pF$ ). In some applications (D/A deglitcher, A/D converter) the gain error can be adjusted elsewhere in the system, while in other applications it must be adjusted at the sample-and-hold. The two circuits shown below demonstrate how to adjust gain error at the sample-and-hold.

The recommended procedure for adjusting gain error is:

1. Perform offset adjustment.
2. Apply the nominal input voltage that should produce a +10V output.
3. Adjust the trim pot for +10V output in the hold mode.
4. Apply the nominal input voltage that should produce a -10V output.
5. Measure the output hold voltage ( $V_{-10}$  NOMINAL). Adjust the trim pot for an output hold voltage of

$$\frac{(V_{-10} \text{ NOMINAL}) + (-10V)}{2}$$

### INVERTING CONFIGURATION

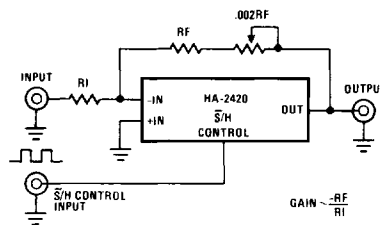


FIGURE 3.

### NONINVERTING CONFIGURATION

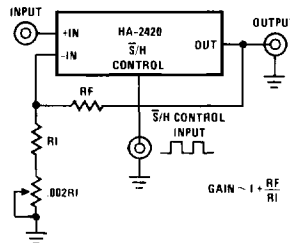


FIGURE 4.